

# **Series 501 Standard DIP Socket** w/Bifurcated Contacts & Wire Wrap Pins

#### **FEATURES**

Bifurcated Contacts in Standard DIP Sockets with Solder Tails or Wire Wrap Pins

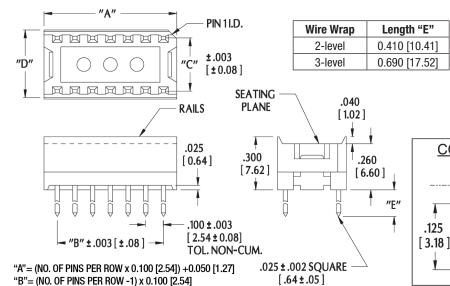
#### **GENERAL SPECIFICATIONS**

- STANDARD BODY: Black UL 94V-0 Glass-filled 4/6 Nylon
- BIFURCATED CONTACTS: Grade A Spring-tempered Phosphor Bronze per QQ-B-750
- PIN PLATING: 10μ [0.25μ] min. Au per MIL-G-45204 over 50μ [1.27μ] min. Ni per SAE AMS-QQ-N-290B; -OR- 200µ [5.08µ] min. matte Sn per ASTM B545-97(2004)e1 over 50µ [1.27µ] min. Ni per SAE AMS-QQ-N-290B; -OR- 200μ [5.08μ] min. 90/10 Sn/Pb per MIL-T-10727 Type 1 over 50μ [1.27µ] min. Ni per SAE AMS-QQ-N-290B
- CONTACT CURRENT RATING: 1.5 amps
- INSERTION FORCE: 110g/pin average
- WITHDRAWAL FORCE: 75g/pin average
- OPERATING TEMPERATURE: -67°F to 221°F [-55°C to 105°C] Sn; -67°F to 257°F [-55°C to 125°C] Au
- LEADS ACCEPTED: Flat leads up to 0.014 thick x 0.020 wide [0.36-0.51], Round leads up to 0.020 [0.51] dia.
- LEAD LENGTHS: from seating plane from 0.075-0.160 [1.91-4.06]

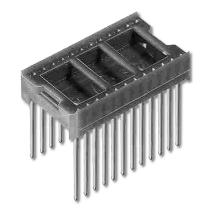
#### **MOUNTING CONSIDERATIONS**

• SUGGESTED PCB HOLE SIZE: 0.045 ±0.002 [1.12 ±0.05] dia.

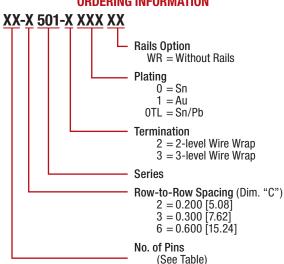
Centers "C"	Width "D"	Available Sizes
0.200 [5.08]	0.290 [7.36]	8, 10
0.300 [7.62]	0.390 [9.90]	8, 14-20
0.600 [15.24]	0.690 [17.54]	8-24, 28-40, 48



**ALL DIMENSIONS: INCHES [MILLIMETERS]** ALL TOLERANCES: ±0.005 [0.13] UNLESS OTHERWISE SPECIFIED FOR SOLDER PIN TAILS, SEE DATA SHEETS 12004 **CONSULT FACTORY FOR OTHER SIZES AND CONFIGURATIONS** 



### **ORDERING INFORMATION**





SEATING PLANE

.160

[4.06]

CONTACT DETAIL

.065

[ 1.65 ]

.125

ARIES RESERVES THE RIGHT TO CHANGE PRODUCT GENERAL SPECIFICATIONS WITHOUT NOTICE

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